CLAIMS

1. A component mounting apparatus comprising

a pair of component supply tables on which components are accommodated and which are arranged on both sides of a board mounting position where a board is positioned;

a first mounting head section for successively picking up the components at one of the component supply tables and thereafter successively mounting the picked-up components onto the board; and

a second mounting head section for successively picking up the components at the other of the component supply tables and thereafter successively mounting the picked-up components onto the board,

wherein the first and second mounting head sections are independently operated.

2. The component mounting apparatus as claimed in claim 1, wherein the first and second mounting head sections are controlled mutually in operation in accordance with a timing at which, when one of them carries out a component picking-up operation for picking up the components from the component supply table, the other of them carries out a component mounting operation for mounting the picked-up components onto the board.

The component mounting apparatus as claimed in

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claim 1, wherein one of the first and second mounting head section has component suction nozzles sucking the components at one time.

- 4. The component mounting apparatus as claimed in claim 2, wherein one of the first and second mounting head section has component suction nozzles sucking the components at one time.
- 5. A component mounting equipment comprising:

 a plurality of component mounting apparatuses

 10 each of which is claimed in Claim 1,

wherein a board transfer path along which the board is supplied to the board mounting position of the apparatus and discharged from the board mounting position of the apparatus by a board transfer device is provided so that the board transfer path connects the board mounting positions of the component mounting apparatuses, and the component supply tables of the component mounting apparatuses are arranged on both sides of the board mounting positions in the board transfer path.

6. A component mounting equipment comprising:

a plurality of component mounting apparatuses
each of which is claimed in Claim 2,

wherein a board transfer path along which the board is supplied to the board mounting position of the apparatus and discharged from the board mounting position of the

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apparatus by a board transfer device is provided so that the board transfer path connects the board mounting positions of the component mounting apparatuses, and the component supply tables of the component mounting apparatuses are arranged on both sides of the board mounting positions in the board transfer path.

- 7. The component mounting equipment as claimed in Claim 5, wherein the components to be mounted onto the single board are all distributed into groups by type, and the components of the groups are accommodated in the component supply tables of the component mounting apparatuses as assigned thereto.
- 8. The component mounting equipment as claimed in Claim 6, wherein the components to be mounted onto the single board are all distributed into groups by type, and the components of the groups are accommodated in the component supply tables of the component mounting apparatuses as assigned thereto.
- 9. A component mounting method comprising steps of:

 picking up by a first mounting head section

 components from one of a pair of component supply tables on

 which the components are accommodated and which are

 arranged on both sides of a board mounting position where

 a board is positioned, the first mounting head section

 syccessively picking up the components at one of the

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component supply tables;

thereafter successively mounting the components picked up by the first mounting head section/onto the board;

picking up by a second mounting head section components from the other of the pair of component supply tables, the second mounting head section successively picking up the components at the other of the component supply tables; and

thereafter successively mounting the components picked up by the second/mounting head section onto the board.

wherein the picking up and mounting steps of the first mounting head section and the picking-up and mounting steps of the second mounting head section are independently carried out.

- The component mounting method as claimed in claim 9, wherein the picking-up step of the first mounting head section and the mounting step of the second mounting head section are/carried out at the same time, and the mounting step of the first mounting head section and the picking-up step of the second mounting head section are carried out at the same time.
- The component mounting method as claimed in claim 9,/wherein in a component mounting equipment comprising a

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plurality of component mounting apparatuses each of which comprises the first and second mounting head sections and the pair of component supply tables between which a board transfer path along which the board is supplied to the board mounting position of the apparatus and discharged from the board mounting position of the apparatus by a board transfer device is provided so that the board transfer path connects the board mounting positions of the component mounting apparatuses, and the component supply tables of the component mounting apparatuses are arranged on both sides of the board mounting positions in the board transfer path,

the picking-up and mounting steps of the first mounting head section and the picking-up and mounting steps of the second mounting head section are sequentially carried out.

- 12. The component mounting method as claimed in claim
 11, wherein the picking-up step of each of the first
 mounting head sections and the mounting step of each of the
 corresponding second mounting head sections are carried out
 at the same time, and the mounting step of each of the
 first mounting head sections and the picking-up step of
 each of the corresponding second mounting head sections are
 carried out at the same time.
 - 13. The component mounting equipment as claimed in

Claim 11, wherein the components to be mounted onto the single board are all distributed into groups by type, and the components of the groups are accommodated in the component supply tables of the component mounting apparatuses as assigned thereto.

14. The component mounting equipment as claimed in Claim 12, wherein the components to be mounted onto the single board are all distributed into groups by type, and the components of the groups are accommodated in the component supply tables of the component mounting apparatuses as assigned thereto.

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